**Preferred Device** 

# Small Signal MOSFET 200 mAmps, 60 Volts

N-Channel TO-92

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Drain Source Voltage	V <sub>DSS</sub>	60	Vdc
Drain–Gate Voltage (R <sub>GS</sub> = 1.0 M $\Omega$ )	V <sub>DGR</sub>	60	Vdc
Gate–Source Voltage  – Continuous  – Non–repetitive (t <sub>p</sub> ≤ 50 μs)	V <sub>GS</sub> V <sub>GSM</sub>	±20 ±40	Vdc Vpk
Drain Current - Continuous - Pulsed	I <sub>D</sub>	200 500	mAdc
Total Power Dissipation @ T <sub>C</sub> = 25°C Derate above 25°C	PD	350 2.8	mW mW/°C
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	–55 to +150	°C

#### THERMAL CHARACTERISTICS

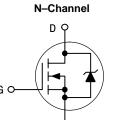
Characteristic	Symbol	Max	Unit
Thermal Resistance, Junction to Ambient	$R_{ heta JA}$	357	°C/W
Maximum Lead Temperature for Soldering Purposes, 1/16" from case for 10 seconds	TL	300	°C



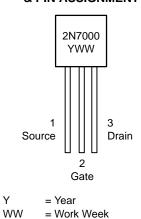
### ON Semiconductor

http://onsemi.com

200 mAMPS 60 VOLTS RDS(on) = 5  $\Omega$ 







#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 3 of this data sheet.

**Preferred** devices are recommended choices for future use and best overall value.

## 2N7000

# **ELECTRICAL CHARACTERISTICS** ( $T_C = 25^{\circ}C$ unless otherwise noted)

Characteristic		Symbol	Min	Max	Unit
OFF CHARACTERISTIC	s			•	•
Drain-Source Breakdown Voltage (V <sub>GS</sub> = 0, I <sub>D</sub> = 10 µAdc)		V(BR)DSS	60	-	Vdc
Zero Gate Voltage Drain Current (VDS = 48 Vdc, VGS = 0) (VDS = 48 Vdc, VGS = 0, TJ = 125°C)		IDSS	_ _	1.0 1.0	μAdc mAdc
Gate–Body Leakage Current, Forward (VGSF = 15 Vdc, VDS = 0)		IGSSF	_	-10	nAdc
ON CHARACTERISTICS	(Note 1.)			•	•
Gate Threshold Voltage (V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 1.0 m/s	V <sub>GS(th)</sub>	0.8	3.0	Vdc	
Static Drain–Source On–Resistance (VGS = 10 Vdc, I <sub>D</sub> = 0.5 Adc) (VGS = 4.5 Vdc, I <sub>D</sub> = 75 mAdc)		r <sub>DS(on)</sub>	- -	5.0 6.0	Ohm
Drain-Source On-Voltage (VGS = 10 Vdc, I <sub>D</sub> = 0.5 Adc) (VGS = 4.5 Vdc, I <sub>D</sub> = 75 mAdc)		VDS(on)	_ _ _	2.5 0.45	Vdc
On–State Drain Current (V <sub>GS</sub> = 4.5 Vdc, V <sub>DS</sub> = 10 Vdc)		I <sub>d(on)</sub>	75	-	mAdc
Forward Transconductance (V <sub>DS</sub> = 10 Vdc, I <sub>D</sub> = 200 mAdc)		9fs	100	-	μmhos
DYNAMIC CHARACTER	ISTICS			•	•
Input Capacitance		C <sub>iss</sub>	-	60	pF
Output Capacitance	$(V_{DS} = 25 \text{ V}, V_{GS} = 0,$	C <sub>oss</sub>	-	25	1
Reverse Transfer Capacitance	f = 1.0 MHz)	C <sub>rss</sub>	_	5.0	
SWITCHING CHARACTI	ERISTICS (Note 1.)				•
Turn-On Delay Time	$(V_{DD} = 15 \text{ V}, I_{D} = 500 \text{ mA},$ $R_{G} = 25 \Omega, R_{L} = 30 \Omega, V_{gen} = 10 \text{ V})$	ton	_	10	ns
Turn-Off Delay Time		t <sub>off</sub>	-	10	1

<sup>1.</sup> Pulse Test: Pulse Width ≤ 300 μs, Duty Cycle ≤ 2.0%.

### 2N7000

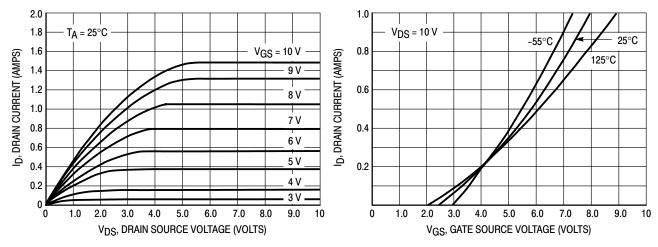


Figure 1. Ohmic Region

Figure 2. Transfer Characteristics

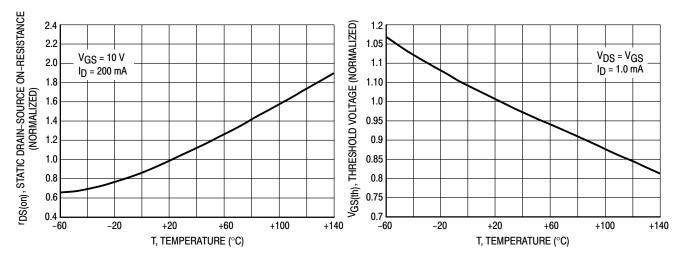


Figure 3. Temperature versus Static Drain–Source On–Resistance

Figure 4. Temperature versus Gate Threshold Voltage

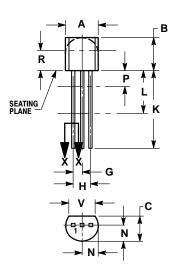
#### **ORDERING INFORMATION**

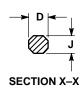
Device	Package	Shipping
2N7000	TO-92	1000 Unit/Box
2N7000RLRA	TO-92	2000 Tape & Reel
2N7000RLRM	TO-92	2000 Ammo Pack
2N7000RLRP	TO-92	2000 Ammo Pack
2N7000ZL1	TO-92	2000 Ammo Pack

#### 2N7000

#### PACKAGE DIMENSIONS

TO-92 CASE 29-11 ISSUE AL





- DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
  - CONTROLLING DIMENSION: INCH.
- CONTOUR OF PACKAGE BEYOND DIMENSION R
- IS UNCONTROLLED.
  LEAD DIMENSION IS UNCONTROLLED IN P AND BEYOND DIMENSION K MINIMUM.

	INCHES		MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.175	0.205	4.45	5.20
В	0.170	0.210	4.32	5.33
С	0.125	0.165	3.18	4.19
D	0.016	0.021	0.407	0.533
G	0.045	0.055	1.15	1.39
Н	0.095	0.105	2.42	2.66
J	0.015	0.020	0.39	0.50
K	0.500		12.70	
L	0.250		6.35	
N	0.080	0.105	2.04	2.66
P		0.100		2.54
R	0.115		2.93	
v	0.135		3 43	

STYLE 22: PIN 1. SOURCE 2. GATE 3 DRAIN

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